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- (7) Applicant: MITSUI TOATSU CHEMICALS, **INCORPORATED** 2-5, 3-chome, Kasumigaseki Chiyoda-ku Tokyo(JP)
- Inventor: Hagimura, Atsushi 1-4-21-204 Kobukurodani

Kamakura-shi, Kanagawa(JP) Inventor: Nishihara, Kunio 3224-48 Nakata-cho, Izumi-ku Yokohama-shi, Kanagawa(JP) Inventor: Nakajima, Mutsuo

2-27-21 Izumi

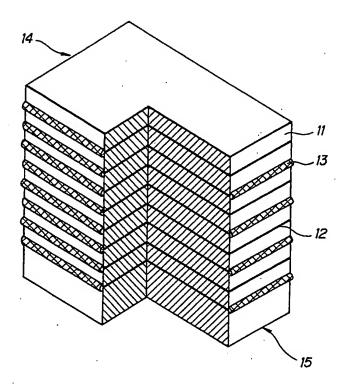
Suginami-ku, Tokyo(JP) Inventor: Inage, Ikuo

621 Nobamachi, Kounan-ku Yokohama-shi, Kanagawa(JP)

- Representative: Hayward, Denis Edward Peter et al Lloyd Wise, Tregear & Co. Norman House 105-109 Strandand London WC2R 0AE(GB)
- Multi-layered ceramic elements and method for producing same.
- (a) A multi-layered ceramic element which comprises a plurality of films or thin plates of ceramic and a plurality of inner electrodes which are alternatively arranged in layers, wherein the ends of the inner electrodes are exposed at side end faces of the multi-layered assembly and only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the electrodes are covered with an insulating layer which comprises a polyimide resin having repeating units represented by the following general formula (I):

wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polybiphenyl groups in which at least one pf either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂; alkylene groups; and xylylene groups and optionally an insulating filler, as well as a method for producing the multi-layered ceramic element.

FIG. 2(a)



MULTI-LAYERED CERAMIC ELEMENTS AND METHOD FOR PRODUCING SAME

BACKGROUND OF THE INVENTION

5 Field of the Invention

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The present invention relates to a multi-layered ceramic element and more specifically to a multi-layered ceramic condenser element and a multi-layered electrostrictive/piezoelectric ceramic element as well as to a method for producing these elements.

Description of the Prior Art

Up to now, multi-layered ceramic elements comprising ceramic films or thin plates and inner electrodes which are superimposed alternatively, for instance, multi-layered ceramic condenser elements and multi-layered electrostrictive/piezoelectric ceramic elements have usually been produced according to the following method. A starting composition is first mixed and calcined, then a proper binder and a solvent are mixed with the calcined powder and the resulting mixture is formed into a thin film or plate by a doctor blade technique. A metal electrode is printed on the thin film and a plurality of such thin films on which the metal electrodes are printed are arranged in layers. Every other metal electrode plate in the resulting multi-layered assembly is connected to one of two external electrodes, one of which serves as a positive electrode and the other of which serves as a negative electrode. In this production method, it is required to decrease the area of the overlap between the positive and negative electrodes as compared with the overall cross section of the multi-layered assembly as shown in Fig. 1, but this leads to the exclusion of the overlap between the electrode plates at the periphery of the assembly. In Fig. 1, the reference numeral 1 represents a dielectric ceramic, 2 an inner electrode and 3 an external electrode.

The electrostatic capacity of a condenser is in general proportional to the area of the overlap between electrodes present in a multi-layered ceramic condenser. However, the entire cross section of the ceramic thin film cannot be used in the foregoing condenser. This becomes a major obstacle in obtaining a small-sized condenser having a high capacity. On the other hand, when an electric voltage is applied to a multi-layered electrostrictive/piezoelectric ceramic element, a relatively large displacement is generated at the overlap between electrode plates. As a result, strain centers in the vicinity of the boundary between the overlapped and non-overlapped portions of the electrodes. Thus, the ceramic is often broken and the inner electrode is sometimes damaged such as peeling off of the same if an electric voltage is applied to the element for a long period of time or a voltage is repeatedly applied thereto. Moreover, the precision for printing inner electrodes must be improved and highly precise alignment of green sheets must be enhanced when they are arranged in layers to produce such a multi-layered ceramic condenser element and a multi-layered electrostrictive/piezoelectric ceramic element. This is a major obstacle in improving the productivity thereof.

One method for eliminating the foregoing drawback has been proposed in Japanese Patent Unexamined Published Application (hereinafter referred to as "J.P. KOKAI") No. Sho 59-115579 which relates to an electrostriction effect element. The application discloses a method for producing an electrostriction effect element which comprises forming an inorganic insulating layer on all the areas of the electrodes exposed at the side end faces of the element or on such areas of every other electrode by making use of an electrophoresis technique. The foregoing drawback can be eliminated by using such a method, but this method is unfavorable in view of its cost because the inorganic insulating layer (in most cases, made of glass) must be baked at a high temperature. In addition, an inorganic insulating layer in general has good compatibility to ceramic bodies and adheres to the bodies over a wide area thereof. Thus, it is said that the distance between the layers of the multi-layered element must be 100 μ m or more so as to prevent the insulating layers applied onto the areas of the electrodes exposed at the side end faces of the element from being continuous. This means that this method cannot provide condensers having a high electrostatic capacity and a distance between electrodes of 100 μ m or less.

Recently, there has been an increasing demand for a small-sized condenser having a high electrostatic capacity. For this reason, many efforts have been directed to search for ceramics having a high dielectric constant and to reduce the thickness of each ceramic layer constituting a multi-layered cetramic condenser

element. Thus, even elements in which the thickness of each layer is $10~\mu$ m or less have already been made on an experimental basis. With regard to multi-layered electrostrictive/piezoelectric ceramic elements, there has recently been an increasing demand for such elements exhibiting a high quantity of displacement. In order to produce elements having such a high quantity of displacement, it is of great importance to reduce the thickness of each layer of the multi-layered electrostrictive/piezoelectric ceramic element as thin as possible. When the distance between the layers of the multi-layered electrostrictive/piezoelectric ceramic element is $100~\mu$ m or more, it is necessary to apply a high voltage on the order of 100V or more in order to apply an electric field of 10~kV/cm to the multi-layered electrostrictive/piezoelectric ceramic element. The driving voltage of such an element can be reduced by decreasing the distance between the layers constituting the same.

In order to produce multi-layered ceramic condensers and multi-layered electrostrictive/piezoelectric ceramic elements having such thin layers at a high efficiency, the development of a novel method for insulating electrodes which does not possess the drawbacks described above in connection with the method disclosed in J.P. KOKAI No. Sho 59-115579 has been desired.

SUMMARY OF THE INVENTION

Accordingly, a principal object of the present invention is to provide a multi-layered ceramic element as well as a method for producing the same, in which a specific organic insulating material is employed. Thus, the present invention makes it possible to reduce the distance between the layers constituting such an element to 10 to 100µ m, which in turn makes it possible to obtain a small-sized multi-layered ceramic condenser having a high capacity and further to obtain a multi-layered electrostrictive/piezoelectric ceramic element having a high quantity of displacement and capable of being driven at a low electric voltage.

The present invention has been developed to achieve the foregoing object and according to one aspect of the present invention, there is provided a multi-layered ceramic element which comprises a plurality of films or thin plates of ceramic and a plurality of inner electrodes which are alternatively arranged in layers, the ends of the inner electrodes being exposed at side end faces of the multi-layered assembly and only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the inner electrodes being covered with an insulating layer which comprises a polyimide resin having repeating units represented by the following general formula (I):

$$\frac{C_0}{\sqrt{C_0}} \times \frac{C_0}{\sqrt{C_0}} \times \frac{1}{\sqrt{C_0}}$$

wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polyblphenyl groups in which at least one of either the phenyl groups or biphenyl groups groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polyblphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C-(CF₃)₂; alkylene groups; and xylylene groups and optionally an insulating filler.

According to another aspect of the present invention, there is provided a method for producing a multi-layered ceramic element which comprises the steps of immersing a ceramic multi-layered body, the body comprising a plurality of ceramic films or thin plates and a plurality of inner electrodes which are alternatively arranged in layers and the ends of the inner electrodes being exposed at side end faces of the multi-layered body, in an electrophoresis bath for forming a layer which is obtained by neutralizing, with a base, carboxyl groups of a polyamide acid resin having repeating units represented by the following general formula (II):

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wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂; alkylene groups; and xylylene groups and then diluting the resin with water, or in an electrophoresis bath for forming a layer which is prepared by neutralizing, with a base, carboxyl groups of the same polyamide acid resin having repeating units represented by the general formula (II) present in a composition comprising the polyamide acid resin and an insulating filler dispersed therein and then diluting the resin with water; carrying out electrophoresis by passing an electric current through the inner electrodes of the ceramic multi-layered body which serve as anodes to deposit the polyamide acid resin or the mixture of the polyamide acid resin and the insulating filler on only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the electrodes and to thus form a coating layer; and then heat-treating the resulting assembly at a temperature ranging from 80 to 280 °C to convert the polyamide acid resin into its imide form to thus form an insulating layer comprising a polyimide resin represented by the following general formula (I):

$$\frac{1}{\sqrt{\sqrt{\frac{c_0}{c_0}}}} \times \frac{\sqrt{c_0}}{\sqrt{c_0}} \times \sqrt{-\frac{1}{\sqrt{c_0}}}$$

wherein X and Y are the same as those defined above or a combination of the polyimide resin and the insulating filler.

The foregoing polyamide acid resin used in the method according to the present invention may be partially converted into its imide form in advance.

BRIEF EXPLANATION OF THE DRAWINGS

Fig. 1 is a schematic diagram for illustrating a conventional multi-layered ceramic condenser presently available in the market;

Fig. 2 (a) is a schematic diagram for illustrating a multi-layered ceramic element according to the present invention; and

Fig. 2 (b) is a schematic diagram for illustrating a method for insulating a multi-layered ceramic element according to the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

In the foregoing polyimide resins having repeating units represented by the general formula (I) and the polyamide acid resins having repeating units represented by the general formula (II), specific examples of X are as follows:

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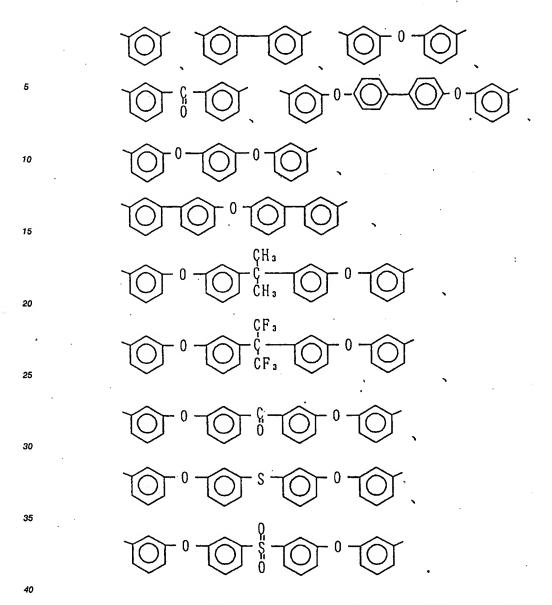
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On the other hand, specific examples of Y in the general formulae (I) and (II) are as follows:



If the adhesion and heat resistance of the polyimide resins having repeating units represented by the general formula (I) to the multi-layered ceramic substrates are taken into consideration, particularly preferred X's are as follows:

and particularly preferred Y's are as follows:

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The polyamide acid resirs having repeating units represented by the general formula (II) used in the method of this invention can be obtained through an addition reaction of tetracarboxylic acid anhydrides represented by the following general formula (III):

$$0 < \frac{c_0}{c_0} > x < \frac{c_0}{c_0} > 0 \qquad (III)$$

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wherein X is the same as that defined above with diamines represented by the following general formula (IV):

 $H_2N - Y - NH_2$ (IV)

wherein Y is the same as that defined above.

Preferred examples of the foregoing tetracarboxylic acid anhydrides are pyromellitic acid dianhydride,

3,3',4,4'-benzophenonetetracarboxylic acid dianhydride,

2,2',3,3'-benzophenonetetracarboxylic acid dianhydride,

3,3',4,4'-biphenyltetracarboxylic acid dianhydride,

5 2,2',3,3'-biphenyltetracarboxylic acid dianhydride,

2,2-bis(3,4-dicarboxyphenyl)propane dianhydride,

2,2-bis(2,3-dicarboxyphenyl)propane dianhydride,

bis(3,4-dicarboxyphenyl) ether dianhydride,

bis(3,4-dicarboxyphenyl) sulfone dianhydride,

1,1-bis(2,3-dicarboxyphenyl) ethane dianhydride.

bis(2,3-dicarboxyphenyl) methane dianhydride,

bis(3,4-dicarboxyphenyl) methane dianhydride,

2,3,6,7-naphthalenetetracarboxylic acid dianhydride,

1,4,5,8-naphthalenetetracarboxylic acid dianhydride,

45 1,2,5,6-naphthalenetetracarboxylic acid dianhydride,

1,2,3,4-benzenetetracarboxylic acid dianhydride,

3,4,9,10-perylenetetracarboxylic acid dianhydride,

2,3,6,7-anthracenetetracarboxylic acid dianhydride and

1,2,7,8-phenanthrenetetracarboxylic acid dianhydride. Particularly preferred tetracarboxylic acid dianhydrides are pyromellitic acid dianhydride,

3,3',4,4'-benzophenonetetracarboxylic acid dianhydride,

3,3',4,4'-bisphenyltetracarboxylic acid dianhydride and

bis(3,4-dicarboxyphenyl) ether dianhydride.

Specific examples of the aforesald diamines are metadiamines such as 3,3'-diaminobenzophenone, 1,3-bis(3-aminophenoxy)benzene, 4,4'-bis(3-aminophenoxy)biphenyl, 2,2-bis [4-(3-aminophenoxy)phenyl] propane, 2,2-bis [4-(3-aminophenoxy)phenyl] -1,1,1,3,3,3-hexafluoropropane, bis [4-(3-aminophenoxy)phenyl] sulfide, bis [4-(3-aminophenoxy) phenyl] ketone and bis [4-(3-aminophenoxy)phenyl] sulfone. These amines can be used alone or in combination of two or more of them.

The reaction of the foregoing tetracarboxylic acid anhydride with the diamine is generally performed in an organic solvent. Examples of such organic solvents are N-methyl-2-pyrrolidone, N,N-dimethylacetamide, N,N-dimethylacetamid

The reaction temperature in general ranges from -20 °C to 200 °C, preferably -10 °C to 50 °C and more preferably 0 °C to room temperature.

The pressure of the reaction is not restricted to a particular range, but the reaction can be carried out at atmospheric pressure effeciently.

The reaction time varies depending on various factors such as the kinds of solvents used, the reaction temperature selected and the kinds of diamines and acid dianhydrides used. However, it in general takes 2 to 40 hours and preferably 4 to 24 hours to complete the formation of polyamide acid resins.

The solution of the polyamide acid resin thus obtained desirably contains 5 to 40% by weight of the polyamide acid resin and has a logarithmic viscosity ranging from 0.5 to 4 dt/g (determined at 35 °C, on a 0.5 g/m² solution in N,N-dimethylacetamide) from the viewpoint of the water-solubility and film-forming properties of the polyimide obtained after heat-treatment.

In the present invention, an insulating filler may be added to the polyamide acid resin obtained above. Any method for adding such an insulating filler may be employed as long as the insulating filler can be uniformly dispersed in the polyamide acid resin. Examples of such methods are roll kneading and ball milling techniques. The amount of the insulating filler preferably ranges from 2 to 70% by volume on the basis of the total volume of the mixture. If the amount thereof is too small, the intended effect of the filler cannot be attained, while if it is too great, the insulating filler causes precipitation in the final electrophoresis bath.

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The insulating fillers usable in the present invention may be either inorganic or organic compounds as long as they have an electric resistivity on the order of not lower than $10^5~\Omega~$ cm. Examples of inorganic compounds used as such insulating fillers are oxides or composite oxides of beryllium, magnesium, calcium, aluminum, boron, silicon, scandium, yttrium, lanthanum, titanium, zirconium, hafnium and rare earth elements; nitrides and oxynitrides of aluminum, boron, silicon, titanium, zirconium, hafnium or the like; and carbides such as silicon carbide. On the other hand, the organic compounds which may be used as such insulating fillers must not be dissolved in the electrophoresis bath and examples of such organic compounds are silicone resins, fluorine plastics represented by Teflons, phenolic resins, furan resins, epoxy resins and acrylic resins.

The insulating fillers may have any shape such as a particulate or fibrous form, but the size thereof is critical and determined as a function of the desired thickness of the resulting insulating layer. More specifically, the maximum diameter of the insulating filler must be smaller than the minimum thickness of the insulating layer. In addition, it is important that the insulating filler be in a well dispersed state in the electrophoresis bath from the industrial point of view. Thus, the average diameter of the insulating filler is not greater than 20 μ m and preferably not greater than 10 μ m.

In the method of the present invention, the polyamide acid resin having the repeating units represented by the general formula (II) becomes soluble in water because COOH groups thereof dissociate into COOTions through the addition of a base such as amines or alkali metal ions in the presence of water or form a stable colloidal dispersion. Therefore, the polyamide acid resin is deposited on inner electrodes (anodes) exposed at the side end faces of a multi-layered element during electrophoresis and is made insoluble in water.

As the foregoing bases, there may be used, for instance, ammonia; secondary amines such as dialkylamines, diethanolamine and morpholine; tertiary amines such as triethylamine, tributylamine, triethanolamine, triisopropanolamine, dimethylethanolamine, dimethylisopropanolamine, diethylethanolamine and dimethylbenzylamine; and inorganic bases such as sodium hydroxide and potassium hydroxide. Particulatly preferred are tertiary amines in view of their stability after diluting with water and properties of the resulting film.

The amount of the base required for the polyamide acid resin to be able to be diluted with water in general ranges from 30 to 110 mole% and preferably 40 to 100 mole% with respect to the carboxyl equivalent of the polyamide acid to be neutralized. Thus, the polyamide acid becomes completely water-soluble or partially soluble in water to form a suspension by such neutralization. Thus, the polyamide acid resin can be diluted with water.

An electrophoresis bath for forming layers can thus be obtained by diluting the neutralized composition

with water. Therefore, the bath comprises a suspension containing the polyamide acid resin and optionally an insulating filler.

The coated layer of the polyamide acid resin or a combination of the polyamide acid resin and the insulating filler thus deposited is converted into an insulating layer composed of a polyimide resin having the repeating units represented by the general formula (I):

$$\frac{C_0}{\sqrt{C_0}} \times \frac{C_0}{\sqrt{C_0}} \times \frac{C$$

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wherein X is the same as that defined above or a combination of such a polyimide resin and the insulating filler by heat-treating the coated layer at a temperature ranging from 80 to 280°C and preferably 150 to 250°C.

The insulating layer of a polyimide resin or a combination of a polyimide resin and an insulating filler thus prepared is excellent in dielectric strength as well as adhesion to metals.

The multi-layered ceramic elements according to the present invention comprises, as illustrated in attached Figs. 2 (a) and 2 (b), a plurality of ceramic films or thin plates and a plurality of inner electrodes which are alternatively arranged in layers. The inner electrodes are present on both upper and lower sides of each ceramic film or thin plate over the whole surface thereof and their ends are exposed at the side end faces of the multi-layered ceramic element. The edge of each inner electrode is connected to either one of positive and negative external electrodes so that every neighbouring two inner electrodes are connected to different external electrodes and then the inner electrodes are insulated by an insulating layer containing the foregoing polyimide resin. Such a multi-layered ceramic element can be directly fitted to a circuit by applying a plating layer of Ni, Sn or the like to the aforementioned external electrodes or indirectly fitted to a circuit by fitting leads to the external electrodes and connecting the leads to the circuit.

In addition, the multi-layered ceramic elements may be optionally sealed with an epoxy resin or the like. Fig. 2 (a) is a cross sectional perspective view of the multi-layered ceramic condenser according to the present invention. In Fig. 2 (a), the reference numeral 11 represents a dielectric ceramic film or plate, 12 an inner electrode, 13 an insulating layer containing a polyimide resin, 14 a side end face A and 15 a side end face B. In this figure, the external electrodes on both side end faces A and B are omitted.

Fig. 2 (b) is a cross sectional view of the multi-layered ceramic condenser according to the present invention.

In Fig. 2 (b), the reference numeral 21 represents a dielectric ceramic film or plate, 22 an inner electrode, 23 an insulating layer containing a polyimide resin, 24 an external electrode, 25 a side end face A and 26 a side end face B.

The inner electrodes are formed so that every other electrode is exposed at either one of the side end faces A and B and it is insulated by covering it with an insulating layer.

Ceramics used in the multi-layered ceramic elements of the present invention may be any ceramics conventionally employed in the manufacture of ceramic condensers and electrostrictive/piezoelectric ceramic elements. Specific examples thereof are lead-type perovskite compounds such as (Pb, Ba)(Zr, Ti)O₃, Pb(Zn, Nb)O₃, Pb(Fe, W)O, Pb(Fe, Nb)O₃, Pb(Mg, Nb)O₃, Pb(Ni, W)O₃, Pb(Mg, W)O₃, PbTiO₃, Pb(Zr, Ti) O₃, Pb(Li, Fe, W)O₃, and (Pb_{1-x}. La _x)(Zr_y Ti_{1-y})O₃; lead-type compounds such as Pb₅Ge₃O₁₁; barium-type perovskite compounds such as BaTiO₃, Ba(Ti, Sn)O₃, (Ba, Sr, Ca)TiO₃, (Ba, Ca)(Zr, Ti)O₃ and (Ba, Sr, Ca)(Zr, Ti)O₃; strontium-type perovskite compounds such as SrTiO₃; calcium-type perovskite compounds such as CaTiO₃ and CaZrO₃; and laminar compounds such as Bi₄Ti₃O₁₂. In addition, mixtures thereof can also be employed in the present invention. Besides, natural and/or artificial mica can also be employed as the ceramic thin plate of the present invention.

Examples of materials for the inner electrodes are conductive metal materials such as silver, palladium, gold, platinum, nickel, copper and zinc as well as alloys of these elements.

It is a matter of course that the term "multi-layered bodies" herein used embraces not only those obtained by the so-called green sheet technique but also those obtained by bonding thin plates of sintered materials with adhesives as well as those comprising ceramic thin films and electrodes which are formed according to CVD, PVD methods or the like and are alternatively arranged in layers.

The present invention will be explained in more detail with reference to the following working Examples, but the present invention is not restricted to these specific Examples.

Example 1

53.0 g (0.25 mole) of 3,3'-diaminobenzophenone was dissolved in 240 mt of N,N-dimethylacetamide in a reaction vessel provided with a stirrer, a reflux condenser and a tube for introducing nitrogen gas. To this solution, there was added 78.6 g (0.244 mole) of powdered 3,3',4,4'-benzophenonetetracarboxylic acid dianhydride and the mixture was stirred at 10° C for 24 hours to give a solution of a polyamide acid resin. The logarithmic viscosity of the resulting polyamide acid was found to be 0.6 dt/g. To the polyamide acid solution, there was slowly added 23.9 g (55 mole% with respect to the carboxyl equivalent) of dimethylethanolamine, the mixture was stirred at room temperature for 20 minutes and was diluted with water by gradual addition of 905.3 g of water at room temperature with stirring to thus give an aqueous solution of the polyamide acid (resin concentration = about 10% by weight).

A sample of a multi-layered body was separately produced. The body was comprised of 50 layers arranged in layers, each layer having a thickness of about 50 µm; the ceramic layer having a composition of Pb(Zn, Nb)O₃-Pb(Mg, Nb)O₃-BaTiO₃ type and a dielectric constant of about 9,000; the inner electrodes being mainly composed of silver and palladium. Every other inner electrode was exposed at one side end face of the body while all of the inner electrodes were exposed at the other side end face thereof. A silver electrode was baked on the side end face on which every other inner electrode was exposed and a lead was connected to the silver electrode with solder. The foregoing aqueous solution was introduced into a plastic tank to obtain an electrophoresis bath for forming layers, the multi-layered body to be coated which served as an anode was immersed in the solution and the lead was connected to an anodic power supply. An electric voltage of 60 V was applied for 4 seconds to perform electrophoresis. Thereafter, the multilayered body was withdrawn from the bath, washed with water and heat-treated at 150 °C for 2 hours and then at 250°C for 3 hours to perform drying and imidation. Then the resulting multi-layered body was cut into two pieces at its center, a silver electrode was applied to the side to which the imide resin-containing insulating film was adhered and a lead was connected thereto with solder. The same procedures were repeated to obtain multi-layered bodies in which each electrode has insulating layers at the both right and left sides. It was confirmed that the thickness of the insulating layer was on the order of 50 μ m and that the dielectric strength thereof was not lower than 500 V.

Example 2

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53.0 g (0.25 mole) of 3,3′-diaminobenzophenone was dissolved in 240 m1 of N,N-dimethylacetamide in a reaction vessel provided with a stirrer, a reflux condenser and a tube for introducing nitrogen gas. To the solution there was added 78.6 g (0.244 mole) of powdered 3,3′,4,4′-benzophenonetetracarboxylic acid dianhydride and the mixture was stirred at 10° C for 24 hours to obtain a polyamide acid solution. 620 g of alumina powder (available from Sumitomo Chemical Company, Limited under the trade name of AKP-30) was added to the solution and the mixure was kneaded with a three-roll mill to give an alumina-dispersed polyamide acid varnish. 21.7 g (50 mole% with respect to the carboxyl equivalent) of dimethylethanolamine was slowly added to the varnish, the resulting mixture was stirred at room temperature for 20 minutes and diluted with water by gradual addition of 905.3 g of water with stirring at room temperature to thus obtain a suspension of polyamide acid resin containing alumina powder.

The same sample of the multi-layered body used in Example 1 was employed, a silver electrode was baked on the side at which every other metal electrode was exposed and a lead was connected thereto with solder. The suspension prepared above was introduced into a plastic tank to obtain an electrophoresis bath for forming films, the multi-layered body to be coated which served as an anode was immersed in the solution and the lead was connected to an anodic power supply. An electric voltage of 20 V was applied for 5 seconds to perform electrophoresis. Thereafter, the multi-layered body was withdrawn from the bath, washed with an aqueous solution containing 20% by weight of N,N-dimethylacetamide and heat-treated at 150 °C for 2 hours and then at 250 °C for 3 hours to perform drying and imidation. Then the resulting multi-layered body was cut into two pieces at its center, a silver electrode was applied to the side to which the imide resin-containing insulating film was adhered and a lead was connected thereto with solder. The same procedures were repeated to obtain multi-layered bodies in which each electrode has insulating layers at both the right and left sides. It was confirmed that the thickness of the insulating layer was on the order of 50µ m.

The dielectric strength of the multi-layered body thus obtained was determined and found to be not lower than 500V.

Example 3

To a reaction vessel equipped with a stirrer, a reflux condenser and a tube for introducing nitrogen gas, there were introduced 41.0 g (0.1 mole) of 2,2-bis [4-(3-aminophenoxy)phenyl] propane and 200 m1 of N,N-dimethylacetamide, the contents of the vessel were cooled down to around 0°C, 21.8 g (0.1 mole) of powdered pyromellitic acid dianhydride was added to the contents of the vessel under a nitrogen gas atmosphere and the mixture was stirred at a temperature of around 0°C for 2 hours. Then the temperature of the solution was brought back to room temperature and it was stirred for about 20 hours under a nitrogen gas atmosphere. The logarithmic viscosity of the resulting polyamide acid was found to be 1.5 d1/g. To the polyamide acid solution, 20.2 g (100 mole% with respect to the carboxyl equivalent) of triethylamine was slowly added, the mixture was stirred at room temperature for one hour and diluted with water by gradual addition of 973 g of water with stirring to thus obtain an aqueous solution of polyamide acid resin (resin concentration = about 5% by weight).

As in the same manner used in Example 1, a sample of the multi-layered body was prepared, an insulating layer was formed on the sample using the polyamide acid resin solution prepared above. It was found that the thickness of the resulting insulating layer was 50 μ m and that the dielectric strength thereof was not lower than 500 V.

20 Example 4

To a vessel provided with a stirrer, a reflux condenser and a tube for introducing nitrogen gas, there were added 41.0 g (0.1 mole) of 2,2-bis [4-(3-aminophenoxy)phenyl] propane and 219.6 g of N,N-dimethylacetamide, 31.6 g (0.098 mole) of 3,3',4,4'-benzophenonetetracarboxylic acid dianhydride in the form of dried solid as such was added, in small portions, to the contents of the vessel at room temperature under a nitrogen gas atmosphere while care was taken not to increase the temperature of the solution and the mixture was stirred at room temperature for 23 hours. The logarithmic viscosity of the resulting polyamide acid solution was found to be 0.70 d1/g. To the polyamide acid solution, 14.6 g (50 mole% with respect to the carboxyl equivalent) of triethanolamine was slowly added, the mixture was stirred at 40° C for 2 hours and diluted with water by gradual addition of 117.2 g of water with stirring to thus obtain an aqueous solution of polyamide acid resin (resin concentration = about 15% by weight).

As in the same manner used in Example 1, a sample of the multi-layered body was prepared, an insulating layer was formed on the sample using the polyamide acid resin solution prepared above. It was found that the thickness of the resulting insulating layer was 50µm and that the dielectric strength thereof was not lower than 500 V.

Example 5

The same procedures used in Example 2 were repeated to form a multi-layered ceramic element except that silica powder (average particle size = 0.5µ m) was substituted for the alumina powder used in Example 2. The dielectric breakdown voltage of the resulting sample was found to be not lower than 500 V.

45 Example 6

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The same procedures used in Example 2 were repeated to form a multi-layered ceramic element except that silicon nitride powder (average particle size = 0.8 μ m) was substituted for the alumina powder used in Example 2. The dielectric breakdown voltage of the resulting sample was found to be not lower than 500 V.

Example 7

The same procedures used in Example 2 were repeated to form a multi-layered ceramic element except that titania powder (average particle size = 0.8 μ m) was substituted for the alumina powder used in Example 2. The dielectric breakdown voltage of the resulting sample was found to be not lower than 500 V.

Example 8

The same procedures used in Example 2 were repeated to form a multi-layered ceramic element in which the ceramic layer had a composition of (Pb,Ba)(Zr,Ti)O₃-La₂O₃ type. The element showed a piezoelectricity. The dielectric breakdown voltage of the element was found to be not lower than 500 V. And the strain of the element at 10 kV/cm was found to be nearly equal to that of a mono-layer element.

Example 9

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The same procedures used in Example 2 were repeated to form a multi-layered ceramic element in which the ceramic layer had a composition of (Pb,Ba)(Zr,Ti)O₃-Nd₂O₃ type. The element showed an electrostricity. The dielectric breakdown voltage of the element was found to be not lower than 500 V. And the strain of the element at 10 kV/cm was found to be nearly equal to that of a mono-layer element.

As seen from the results of the foregoing Examples, the multi-layered ceramic elements of the present invention have high dielectric strength and can be produced by a simple method at a high efficiency as compared with those produced by conventional methods. Thus, multi-layered ceramic elements exhibiting high reliability can be produced at a low cost according to the present invention.

Claims

1. A multi-layered ceramic element which comprises a plurality of films or thin plates of ceramic and a plurality of inner electrodes which are alternatively arranged in layers, wherein the ends of the inner electrodes are exposed at side end faces of the multi-layered assembly and only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the electrodes are covered with an insulating layer which comprises a polyimide resin having repeating units represented by the following general formula (I):

$$\frac{1}{\sqrt{100}} \times \frac{1}{\sqrt{100}} \times \frac{1}$$

wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂; alkylene groups; and xylylene groups.

2. The multi-layered ceramic element of claim 1 wherein the insulating layer comprises a polyimide resin containing an insulating filler.

3. The multi-layered ceramic element of claim 1 wherein the element is a multi-layered electrostrictive/piezoelectric ceramic element.

4. The multi-layered ceramic element of claim 1 wherein the element is a multi-layered ceramic condenser element.

5. A method for producing a multi-layered ceramic element which comprises the steps of immersing a ceramic multi-layered body, the body comprising a plurality of ceramic films or plates and a plurality of inner electrodes which are alternatively arranged in layers and the ends of the inner electrodes being exposed at side end faces of the multi-layered body, in an electrophoresis bath for forming a layer which is obtained by neutralizing, with a base, carboxyl groups of a polyamide acid resin having repeating units represented by the following general formula (II):

wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂; alkylene groups; and xylylene groups and then diluting the resin with water; carrying out electrophoresis by passing an electric current through the inner electrodes of the ceramic multi-layered body which serve as anodes to deposit the polyamide acid resin on only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the electrodes and to thus form a coating layer; and then heat-treating the resulting assembly at a temperature ranging from 80 to 280° C to convert the polyamide acid resin into its imide form to thus form an insulating layer comprising a polyimide resin represented by the following general formula (I):

$$\frac{C_0}{\sqrt{C_0}} \times \frac{C_0}{\sqrt{C_0}} \times \frac{1}{\sqrt{C_0}} \times$$

wherein X and Y are the same as those defined above.

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- 6. The method of claim 5 wherein the multi-layered ceramic element is a multi-layered electrostrictive/piezoelectric ceramic element.
- 7. The method of claim 5 wherein the multi-layered ceramic element is a multi-layered ceramic condenser element.
- 8. A method for producing a multi-layered ceramic element which comprises the steps of immersing a ceramic multi-layered body, the body comprising a plurality of ceramic films or plates and a plurality of inner electrodes which are alternatively arranged in layers and ends of the inner electrodes being exposed at side end faces of the multi-layered body, in an electrophoresis bath for forming a layer which is obtained by neutralizing, with a base, carboxyl groups of a polyamide acid resin having repeating units represented by the following general formula (II):

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wherein X represents a tetravalent group selected from the group consisting of tetravalent phenyl groups; tetravalent biphenyl groups; and tetravalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂ and Y represents a bivalent group selected from the group consisting of phenylene groups; biphenylene groups; bivalent polyphenyl and polybiphenyl groups in which at least one of either the phenyl groups or biphenyl groups are bonded through at least one member selected from the group consisting of O, CO, S, SO₂, CH₂, C(CH₃)₂ and C(CF₃)₂; alkylene groups; and xylylene groups present in a composition comprising the polyamide acid resin and an insulating filler dispersed therein and then diluting the resin with water; carrying out electrophoresis by passing an electric current through the inner electrodes of the ceramic multi-layered body which serve as anodes to deposit the polyamide acid resin and the insulating filler on only the exposed portions of the inner electrodes and the ceramic surface in the vicinity of the exposed portions of the electrodes and to

thus form a coating layer; and then heat-treating the resulting assembly at a temperature ranging from 80 to 280 °C to convert the polyamide acid resin into its imide form to thus form an insulating layer comprising a polyimide resin represented by the following general formula (I):

$$\frac{C_0}{\sqrt{C_0}} \times \frac{C_0}{\sqrt{C_0}} \times \frac{1}{\sqrt{C_0}}$$

wherein X and Y are the same as those defined above and the insulating filler.

- 9. The method of claim 8 wherein the multi-layered ceramic element is a multi-layered electrostrictive/piezoelectric ceramic element.
- 10. The method of claim 8 wherein the multi-layered ceramic element is a multi-layered ceramic condenser element.

FIG. 1

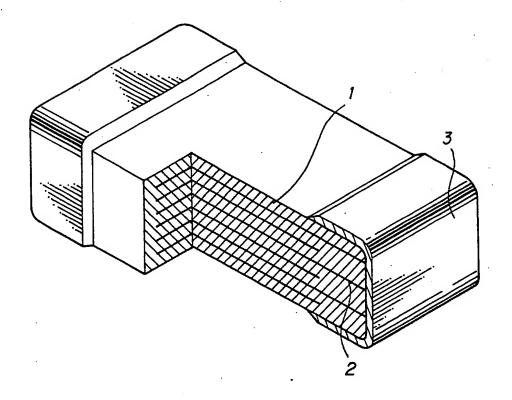


FIG. 2(a)

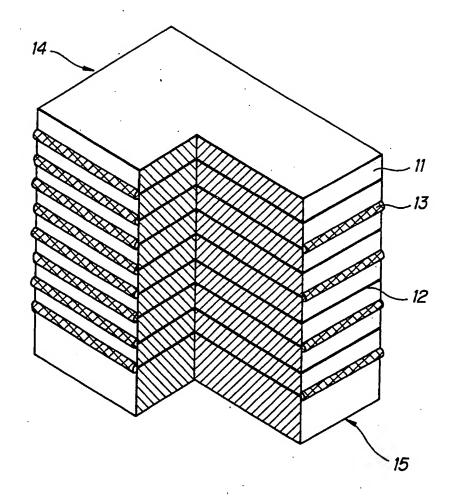
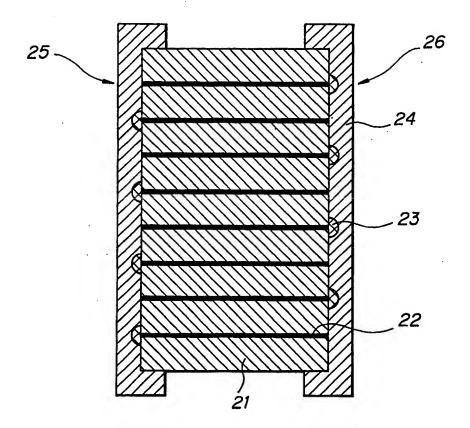


FIG. 2 (b)





EUROPEAN SEARCH REPORT

Application Number

EP 90 30 7104

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	DOCUMENTS CONSI	DERED TO BE RELEV	ANT			
Category	Citation of document with i of relevant pa	ndication, where appropriate,		elevant claim	CLASSIFICATION OF THI APPLICATION (Int. Cl.5)	
Y	EP-A-0 167 392 (NE * page 5, line 17 -	-0 167 392 (NEC) ge 5, line 17 - page 6, line 6; 7, line 6 - page 12, bottom;		LO	H 01 L	41/08
Y	PATENT ABSTRACTS OF vol. 12, no. 30 (E- 1988; & JP-A-621866 15.08.1987 * the wh	578), 28 January 72 (TOSHIBA)	1-1	10		
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		·		•		
:_	The present search report has b	een drawn up for all claims				
	Place of search	Date of completion of the sear	<u> </u>		Examiner	
BI	ERLIN	16-08-1990		MUNN	IIXSJG	
X: particularly relevant if taken alone Y: particularly relevant if combined with another document of the same category E: earlier patent after the filling D: document cit document of the same category L: document cit				ciple underlying the Invention document, but published on, or date d in the application i for other reasons		
O: no	hnological background o-written disclosure ermediate document	. & : member of document	the same pa	tent famil	y, corresponding	

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EUROPEAN SEARCH REPORT

EP 90 30 7104

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Category	Citation of document with indi of relevant passa		to claim	APPLICATION (Int. Cl.5)
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À	PATENT ABSTRACTS OF Color vol. 11, no. 277 (E-5 1987; & JP-A-62076913 09.04.1987 * the whole	338), 8 September 3 (TOSHIBA)	1,5,8	
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	The present search report has been	drawn up for all claims	- - - - - - - - - - - - -	
Place of search		Date of completion of the sea		Examiner
BI	ERLIN	16-08-1990	MUNN	IIX S J G

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- &: member of the same patent family, corresponding document